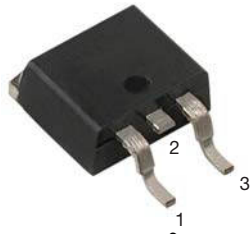
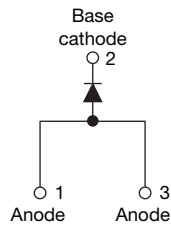


# High Voltage Surface Mount Input Rectifier Diode, 25 A


**TO-263AB (D<sup>2</sup>PAK)**

**FEATURES**

- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Glass passivated pellet chip junction
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**
**APPLICATIONS**

- Input rectification
- Vishay switches and output rectifiers which are available in identical package outlines

**DESCRIPTION**

The VS-25ETS..SPbF rectifier High Voltage Series has been optimized for very low forward voltage drop, with moderate leakage. The glass passivation technology used has reliable operation up to 150 °C junction temperature.

**PRODUCT SUMMARY**

Package	TO-263AB (D <sup>2</sup> PAK)
$I_{F(AV)}$	25 A
$V_R$	800 V, 1000 V, 1200 V
$V_F$ at $I_F$	1.14 V
$I_{FSM}$	300 A
$T_J$ max.	150 °C
Diode variation	Single die

**OUTPUT CURRENT IN TYPICAL APPLICATIONS**

APPLICATIONS	SINGLE-PHASE BRIDGE	THREE-PHASE BRIDGE	UNITS
Capacitive input filter $T_A = 55$ °C, $T_J = 125$ °C common heatsink of 1 °C/W	20	23	A

**MAJOR RATINGS AND CHARACTERISTICS**

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Sinusoidal waveform	25	A
$V_{RRM}$		800 to 1200	V
$I_{FSM}$		300	A
$V_F$	10 A, $T_J = 25$ °C	1.0	V
$T_J$		-40 to +150	°C

**VOLTAGE RATINGS**

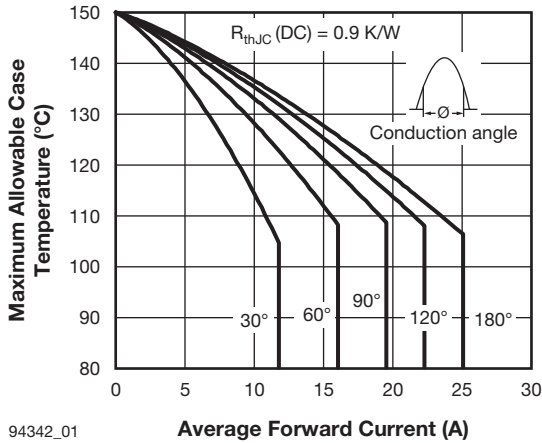
PART NUMBER	$V_{RRM}$ , MAXIMUM PEAK REVERSE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	$I_{RRM}$ AT 150 °C mA
VS-25ETS08SPbF	800	900	1
VS-25ETS10SPbF	1000	1100	
VS-25ETS12SPbF	1200	1300	



<b>ABSOLUTE MAXIMUM RATINGS</b>				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 106\text{ }^\circ\text{C}$ , 180° conduction half sine wave	25	A
Maximum peak one cycle non-repetitive surge current	$I_{FSM}$	10 ms sine pulse, rated $V_{RRM}$ applied	250	
		10 ms sine pulse, no voltage reapplied	300	
Maximum $I^2t$ for fusing	$I^2t$	10 ms sine pulse, rated $V_{RRM}$ applied	316	$A^2s$
		10 ms sine pulse, no voltage reapplied	442	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1\text{ ms to }10\text{ ms}$ , no voltage reapplied	4420	$A^2\sqrt{s}$

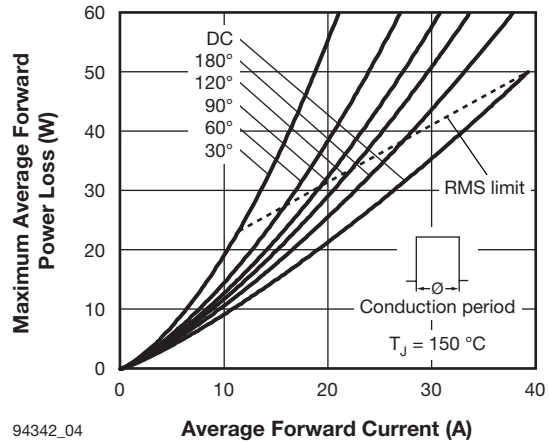
<b>ELECTRICAL SPECIFICATIONS</b>				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum forward voltage drop	$V_{FM}$	25 A, $T_J = 25\text{ }^\circ\text{C}$	1.14	V
Forward slope resistance	$r_t$	$T_J = 150\text{ }^\circ\text{C}$	9.62	$m\Omega$
Threshold voltage	$V_{F(TO)}$		0.87	V
Maximum reverse leakage current	$I_{RM}$	$T_J = 25\text{ }^\circ\text{C}$	$V_R = \text{Rated } V_{RRM}$	0.1
		$T_J = 150\text{ }^\circ\text{C}$		1.0

<b>THERMAL - MECHANICAL SPECIFICATIONS</b>				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$		-40 to +150	$^\circ\text{C}$
Maximum thermal resistance, junction to case	$R_{thJC}$	DC operation	0.9	$^\circ\text{C/W}$
Maximum thermal resistance, junction to ambient	$R_{thJA}$		62	
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased	0.5	
Approximate weight			2	g
			0.07	oz.
Mounting torque	minimum		6 (5)	$\text{kgf} \cdot \text{cm}$ $(\text{lb} \cdot \text{in})$
	maximum		12 (10)	
Marking device		Case style TO-263AB (D <sup>2</sup> PAK)	25ETS08S	
			25ETS10S	
			25ETS12S	



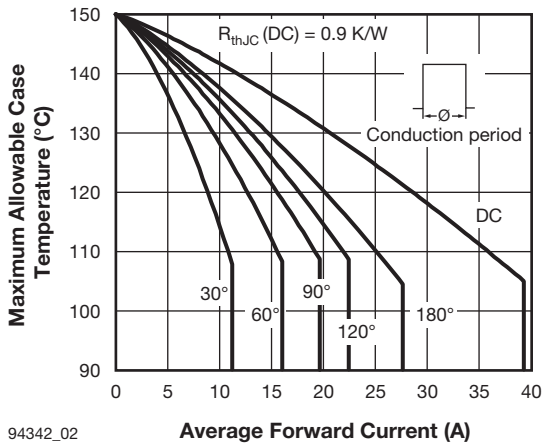
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Fig. 1 - Current Rating Characteristics



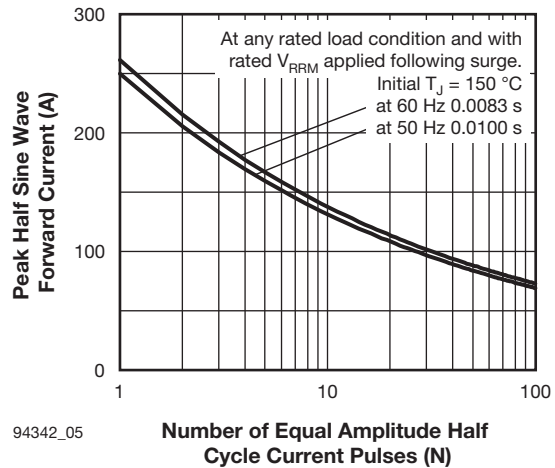
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Fig. 4 - Forward Power Loss Characteristics



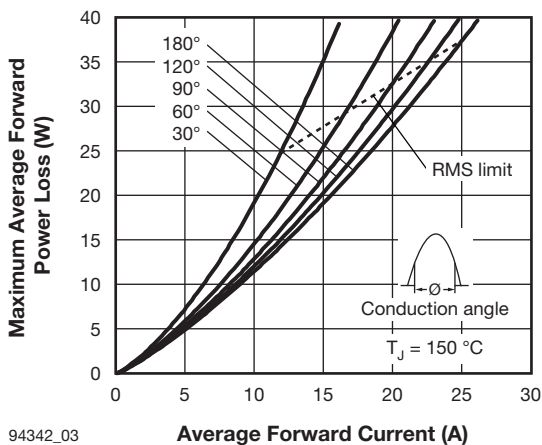
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Fig. 2 - Current Rating Characteristics



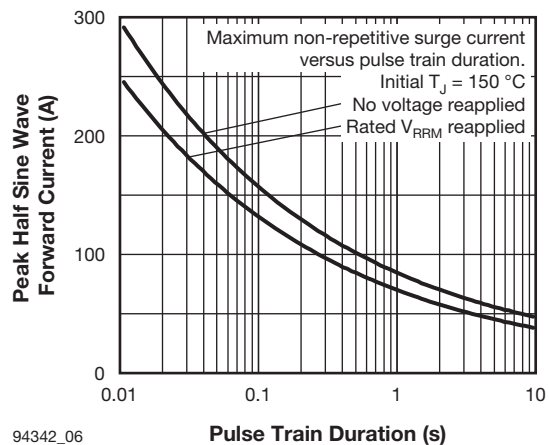
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Fig. 5 - Maximum Non-Repetitive Surge Current



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Fig. 3 - Forward Power Loss Characteristics



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Fig. 6 - Maximum Non-Repetitive Surge Current

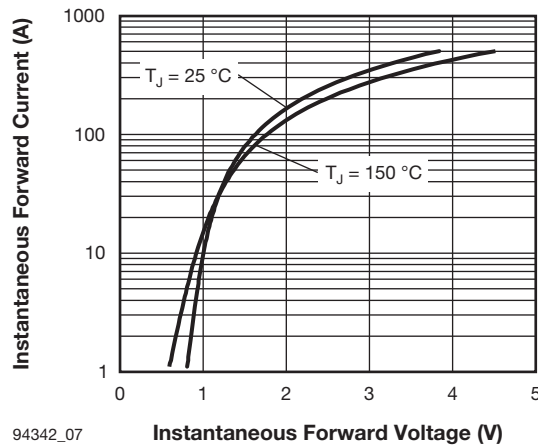


Fig. 7 - Forward Voltage Drop Characteristics

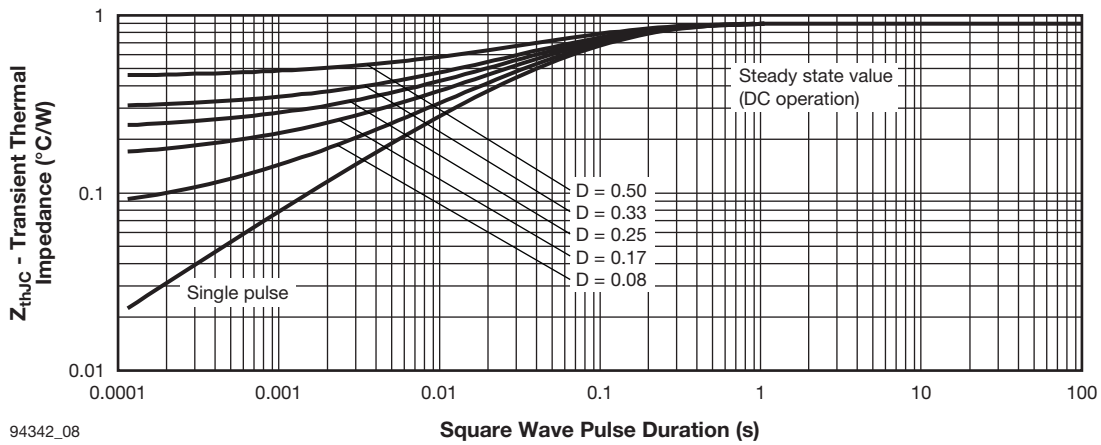
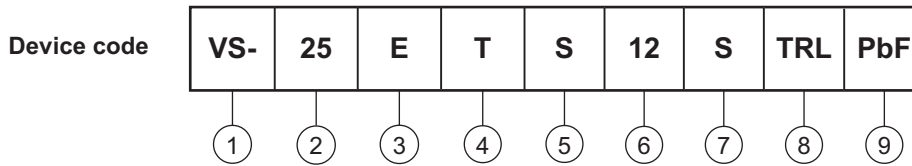


Fig. 8 - Thermal Impedance  $Z_{thJC}$  Characteristics



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (25 = 25 A)
- 3** - Circuit configuration  
E = single diode
- 4** - Package:  
T = TO-220AC
- 5** - Type of silicon:  
S = standard recovery rectifier
- 6** - Voltage code x 100 =  $V_{RRM}$ 

08 = 800 V
10 = 1000 V
12 = 1200 V
- 7** - S = TO-220 D<sup>2</sup>PAK (SMD-220) version
- 8** -
  - None = tube
  - TRL = tape and reel (left oriented)
  - TRR = tape and reel (right oriented)
- 9** - PbF = lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-25ETS08SPbF	50	1000	Antistatic plastic tube
VS-25ETS08STRRPbF	800	800	13" diameter reel
VS-25ETS08STRLPbF	800	800	13" diameter reel
VS-25ETS10SPbF	50	1000	Antistatic plastic tube
VS-25ETS10STRRPbF	800	800	13" diameter reel
VS-25ETS10STRLPbF	800	800	13" diameter reel
VS-25ETS12SPbF	50	1000	Antistatic plastic tube
VS-25ETS12STRRPbF	800	800	13" diameter reel
VS-25ETS12STRLPbF	800	800	13" diameter reel

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>
Part marking information	<a href="http://www.vishay.com/doc?95054">www.vishay.com/doc?95054</a>
Packaging information	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>

## D<sup>2</sup>PAK

### DIMENSIONS in millimeters and inches

Conforms to JEDEC® outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	e	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070		H	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
c	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

#### Notes

- Dimensioning and tolerancing per ASME Y14.5 M-1994
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- Thermal pad contour optional within dimension E, L1, D1 and E1
- Dimension b1 and c1 apply to base metal only
- Datum A and B to be determined at datum plane H
- Controlling dimension: inch
- Outline conforms to JEDEC® outline TO-263AB



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